

REVERSE VOLTAGE - 50 to 1000 Volts SURFACE MOUNT GLASS PASSIVATED RECTIFIERS FORWARD CURRENT - 2.0 Amperes FEATURES SMA Glass passivated chip • For surface mounted applications Low reverse leakage current Low forward voltage drop .062(1.60) .114(2.90) High current capability .055(1.40) .098(2.50) Plastic material has UL flammability classification 94V-0 181(4.60) .157(4.00) .012(.305) .006(.152) MECHANICAL DATA .103(2.62) .079(2.00) •Case: Molded Plastic Polarity:Color band denotes cathode .060(1.52) .008(.203) Weight: 0.002 ounces, 0.053 grams .030(0.76) .002(.051) 208(5.28) Mounting position: Any .188(4.80) Dimensions in inches and (millimeters) MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave ,60Hz, resistive or inductive load. For capacitive load, derate current by 20% **CHARACTERISTICS** SYMBOL S2DA S2KA S2AA S2BA S2GA S2JA S2MA UNIT Maximum Recurrent Peak Reverse Voltage VRRM 50 100 200 400 600 800 1000 V V Maximum RMS Voltage VRMS 35 70 140 280 420 560 700 50 100 200 400 600 800 1000 v Maximum DC Blocking Voltage VDC Maximum Average Forward 2.0 (AV) A **Rectified Current** @TL=100 °C Peak Forward Surge Current 70 8.3ms Single Half Sine-Wave IFSM А Super Imposed On Rated Load (JEDEC Method) 1.1 v Maximum Forward Voltage at 2.0A DC VF 5.0 Maximum DC Reverse Current @TJ=25°C μA IR at Rated DC Blocking Voltage @Tj=125°C 125 20 Typical Junction Capacitance (Note1) CJ pF Typical Thermal Resistance (Note2) Rejl 20 °C/W

NOTES:1.Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

2. Thermal resistance junction to lead.

Operating Temperature Range

Storage Temperature Range

-55 to +150

-55 to +150

°C

°C

ТJ

Tstg



FIG. 1 – FORWARD CURRENT DERATING CURVE

FIG. 2 – MAXIMUM NON-REPETITIVE SURGE CURRENT

